

Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26 D-32758 Detmold

www.weidmueller.com

Germany

#### **Product image**





Similar to illustration

Extra flat high-temperature-resistant two-tier SCDN-THR pin header for reflow soldering.

- Two compact interfaces are used with the flat BCF 3.81 (PUSH IN) socket block.
- Available as 90° (recumbent).
- Connections on a single level, allowing access that is flush over the front board.
- Space for labelling and coding
- Packed in cardboard box.

Weidmüller's 3.81-mm-pitch (0.15 inch) plug-in connectors are compatible with the layouts of standard connectors and offer space for labelling and coding.

#### **General ordering data**

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 3.81 mm, Number of poles: 24, 90°, Solder pin length (I): 3.2 mm, tinned, black, Tape
Order No.	<u>1374880000</u>
Туре	SCDN-THR 3.81/24/90F 3.2SN BK RL
GTIN (EAN)	4050118176056
Qty.	145 pc(s).
Product data	IEC: 320 V / 17.5 A UL: 300 V / 11 A
Packaging	Таре

Creation date March 23, 2021 7:45:46 PM CET



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# **Technical data**

#### **Dimensions and weights**

Depth	13.3 mm	Depth (inches)	0.524 inch
Height	18.4 mm	Height (inches)	0.724 inch
Height of lowest version	15.2 mm	Net weight	14.63 g
Width	56.11 mm	Width (inches)	2.209 inch

#### **System specifications**

Product family	OMNIMATE Signal - series BC/S	SC 3.81			
Type of connection	Board connection				
Mounting onto the PCB	THT/THR solder connection				
Pitch in mm (P)	3.81 mm				
Pitch in inches (P)	0.15 inch				
Outgoing elbow	90°				
Number of poles	24				
Number of solder pins per pole	1				
Solder pin length (I)	3.2 mm				
Solder pin length tolerance	+0,02 / -0,02 mm				
Solder pin dimensions	d = 1.0 mm, Octagonal				
Solder pin dimensions = d tolerance	0 / -0,03 mm				
Solder eyelet hole diameter (D)	1.3 mm				
Solder eyelet hole diameter tolerance (E	0)+ 0,1 mm				
Outside diameter of solder pad	2.1 mm				
Template aperture diameter	1.9 mm				
L1 in mm	41.91 mm				
L1 in inches	1.65 inch				
Number of rows	2				
Pin series quantity	2				
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch				
Touch-safe protection acc. to DIN VDE 0470	IP 20				
Volume resistance	≤5 mΩ				
Can be coded	Yes				
Tightening torque	Torque type		Mounting screw, PCB		
	Usage information		Tightening torque	min.	0.1 Nm
	_			max.	0.15 Nm
			Recommended screw	Part	PTSC KA
				number	2.2X4.5
					<u>WN1412</u>

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	120 °C		

# **Technical data**



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Rated c	lata a	acc.	to	IEC
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tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	17.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	13.2 A	(Tu=40°C)	17 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	12.2 A	pollution degree II/2	320 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	160 V	pollution degree III/3	160 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	2.5 kV	class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage		Short-time withstand current resistance	
class/ contamination degree III/3	2.5 kV		3 x 1s with 76 A

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	11 A	Rated current (Use group D / CSA)	11 A

#### Rated data acc. to UL 1059



GAAAARated voltage (Use group B / UL 1059)300 VRaRated current (Use group B / UL 1059)11 ARa

Reference to approval values

11 A Specifications are maximum values, details see approval certificate. Certificate No. (cURus)

	E60693
Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group D / UL 1059)	11 A

#### Packing

Institute (cURus)

Packaging	Tape	VPE length	90 mm
VPE width	330 mm	VPE height	330 mm
Tape depth (T2)	19.5 mm	Tape width (W)	88 mm
Tape pocket depth (K0)	19 mm	Tape pocket height (A0)	13.6 mm
Tape pocket width (B0)	71.7 mm	Tape pocket separation (P1)	20 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	42.2 mm
Tape reel diameter Ø (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$

#### **Classifications**

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

### Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties
Notes	in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months



#### Approvals

Approvals



E60693

ROHS UL File Number Search



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# Drawings

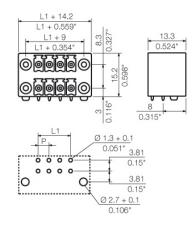


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#### **Dimensional drawing**



Creation date March 23, 2021 7:45:46 PM CET

Catalogue status 12.03.2021 / We reserve the right to make technical changes.

# Wave Solder Profile

## **Recommended wave solderding profiles**

# Weidmüller 🟵

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**Double Wave:** 

Single Wave:



#### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

# **Reflow Solder Profile**

## **Recommended reflow soldering profile**



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Time [sec]

#### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.